



[Handwritten signature]

Atty. Dkt. No. 035905-0164 (MA-100-I)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: S. Brad HERNER et al.
Title: LOW-TEMPERATURE, LOW-
RESISTIVITY HEAVILY
DOPED P-TYPE POLYSILICON
DEPOSITION
Appl. No.: 10/769,047
Filing Date: 1/30/2004
Examiner: Chen, Bret P.
Art Unit: 1792
Confirmation Number: 7037

AMENDMENT AND REPLY UNDER 37 CFR 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the Non-Final Office Action dated November 1, 2007, concerning the above-referenced patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this document.

Remarks/Arguments begin on page 5 of this document.

Please amend the application as follows: